

**Features**

- Low driver power requirements (TTL/CMOS Compatible)
- High reliability
- Arc-Free with no snubbing circuits
- 3750/5000Vrms Input/Output isolation
- Tape & Reel version available

Applications

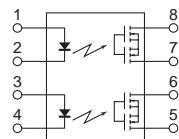
- Telecommunications (PC, Electronic notepad)
- Measuring and Testing equipment
- Industrial control
- Security equipments
- High speed inspection machine



SMD-8

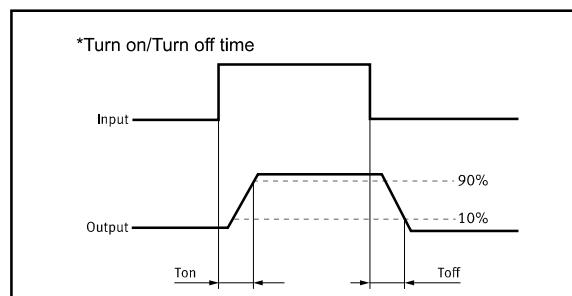


DIP-8



1,3. LED Anode
2,4. LED Cathode
5,6. Drain (MOS FET)
7,8. Source (MOS FET)

(Unit: mm)

**TYPES**

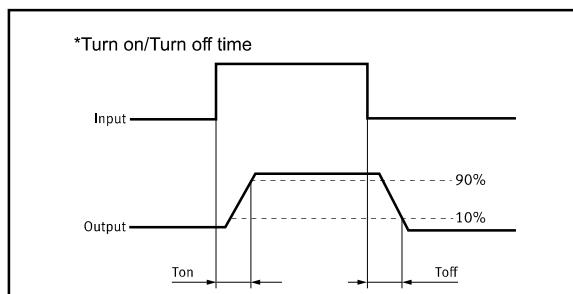
Category	Output rating				Packing quantity
	Load voltage	Load current	Part No.	Package	
AC/DC	60V	500mA	GAQW212GE	DIP-8	25pcs/Tube
			GAQW212GEH	SMD-8	1000pcs/1reel

Absolute Maximum Ratings (Ambient Temperature: 25°C)

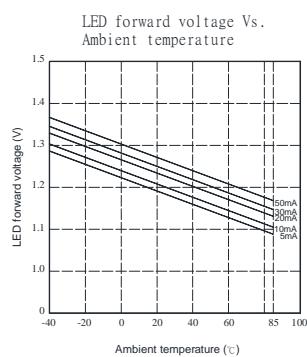
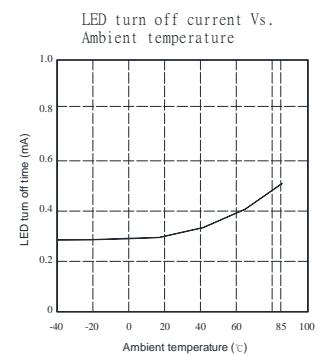
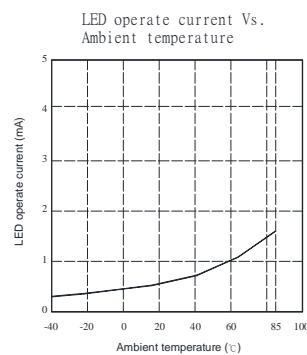
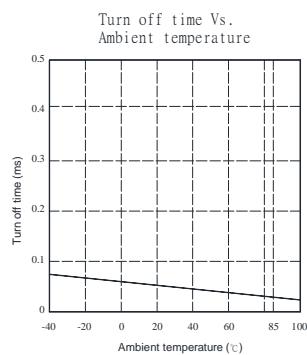
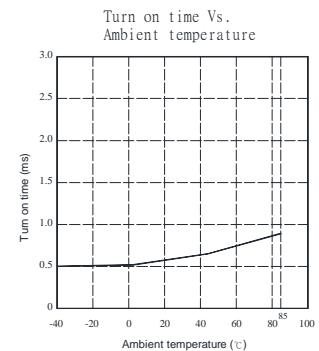
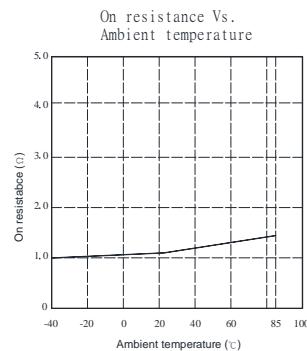
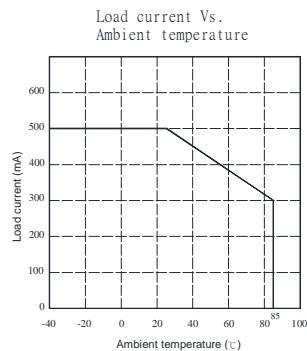
Item	Symbol	Value	Units	Note
Input	Continuous LED Current	I _F	50	mA
	Peak LED Current	I _{FP}	1000	mA
	LED Reverse Voltage	V _R	5	V
	Input Power Dissipation	P _{In}	75	mW
Output	Load Voltage	V _L	60	V(AC peak or DC)
	Load Current	I _L	500	mA
	Peak Load Current	I _{Peak}	1.0	A
	Output Power Dissipation	P _{out}	450	mW
Total Power Dissipation	P _T	500	mW	
I/O Breakdown Voltage	V _{IO}	3750	Vrms	RH=60%, 1min
I/O Breakdown Voltage(Suffix-V)	V _{IO}	5000	Vrms	RH=60%, 1min
Operating Temperature	T _{opr}	-40 to +85	°C	
Storage Temperature	T _{stg}	-40 to +100	°C	
Pin Soldering Temperature	T _{sol}	260	°C	10 sec max.

Electrical Specifications (Ambient Temperature: 25°C)

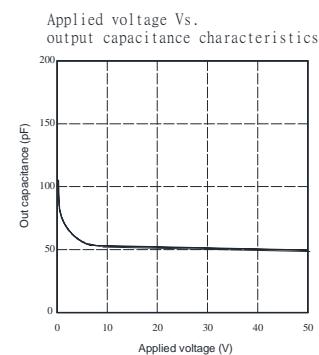
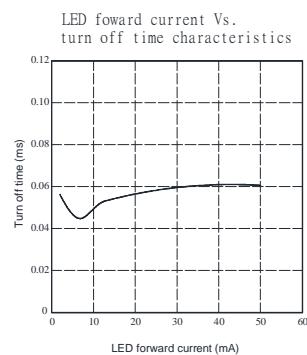
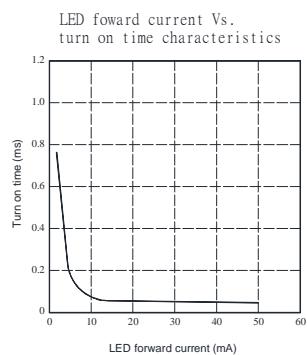
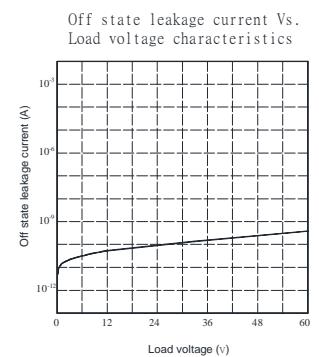
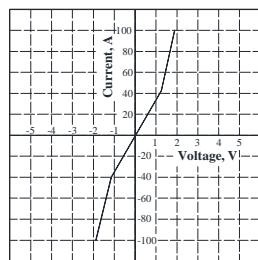
Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V _F		1.2	V	I _F =10mA
	Operation LED Current	I _{F on}		0.5	mA	
	Recovery LED Current	I _{F off}		0.35	mA	
	Recovery LED Voltage	V _{F off}	0.7		V	
Output	On-Resistance	R _{on}		1.0	Ω	I _F =10mA, I _L =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I _{Leak}		1.0	uA	V _L =Rating
	Output Capacitance	C _{out}		115	pF	V _L =0, f=1MHz
Transmission	Turn-On Time	T _{on}		0.5	ms	I _F =10mA, I _L =100mA,
	Turn-Off Time	T _{off}		0.35	ms	
Coupled	I/O Isolation Resistance	R _{IO}	10 ¹⁰		Ω	DC500V
	I/O Capacitance	C _{IO}		0.8	1.5	pF



Reference Data



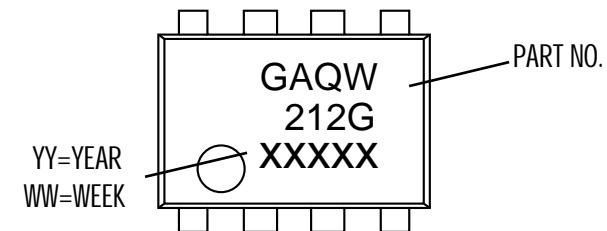
Voltage Vs. current characteristics
of output at MOS portion



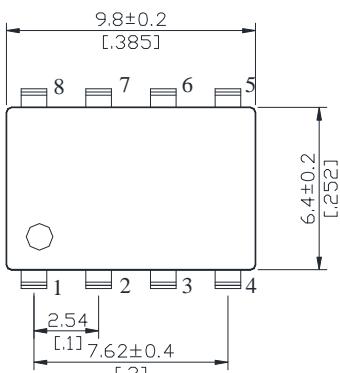
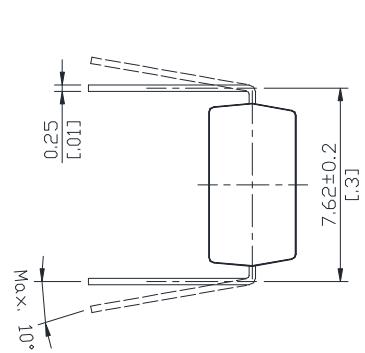
8-DIP

Dimensions

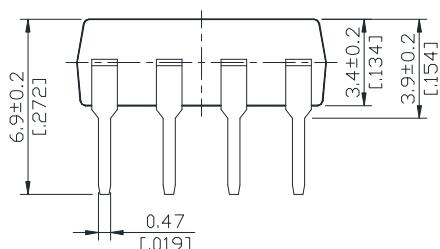
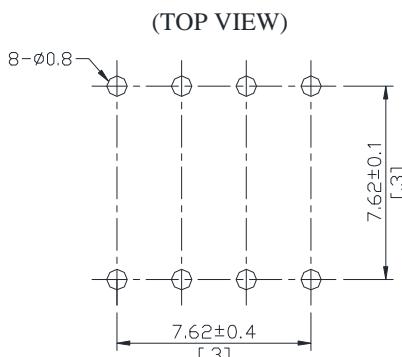
mm inch



Through hole terminal type



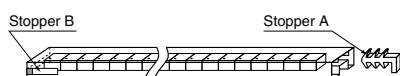
PC board pattern



Unit : mm inch
Tolerance: +0.2 -.007

DIP type

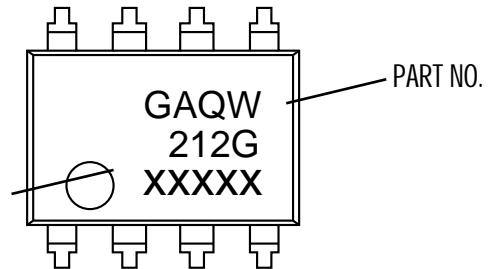
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



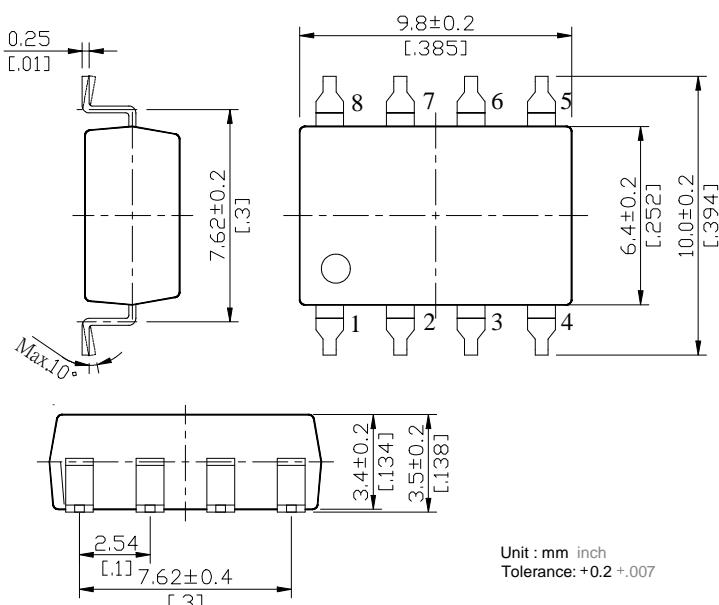
8-SMD

Dimensions

mm inch

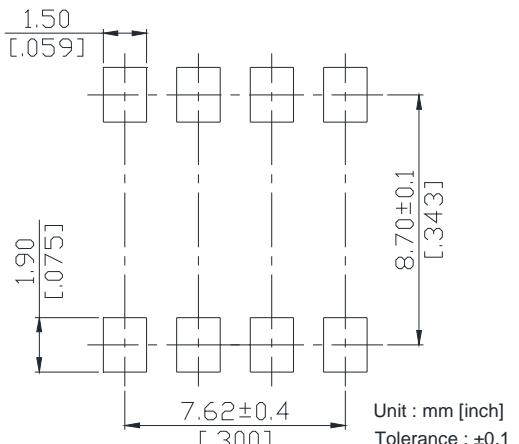


Surface mount terminal type



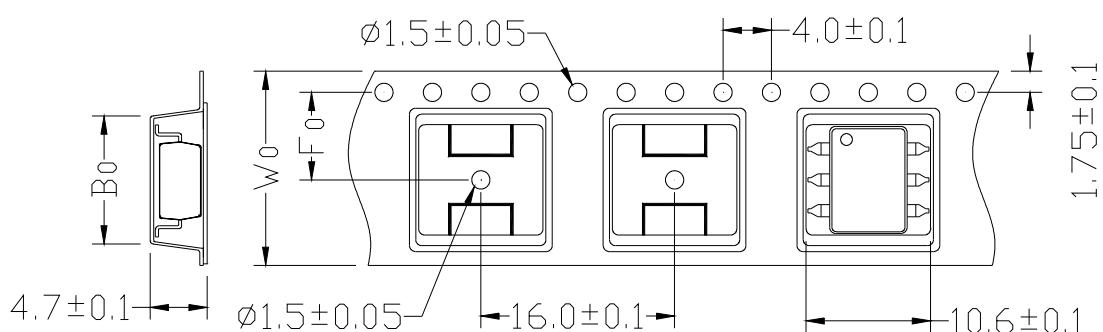
PC board pattern

(Top view)



Tape dimensions

Direction of feed →



Dimensions of tape reel

